

VE320 Homework 8

Due: 10/07/2019 10:00 am

For problem 4-9, assume $A^* = 120 \text{ A/K}^2\text{-cm}^2$ for silicon and $A^* = 1.12 \text{ A/K}^2\text{-cm}^2$ for gallium arsenide Schottky diodes unless otherwise stated.

1.

An npn bipolar transistor is biased in the forward-active mode. (a) The collector current is $I_C = 1.2 \text{ mA}$ when biased at $V_{CE} = 2 \text{ V}$. The Early voltage is $V_A = 120 \text{ V}$. Determine (i) the output resistance r_o , (ii) the output conductance g_o , and (iii) the collector current when biased at $V_{CE} = 4 \text{ V}$. (b) Repeat part (a) if the collector current is $I_C = 0.25 \text{ mA}$ when biased at $V_{CE} = 2 \text{ V}$ and the Early voltage is $V_A = 160 \text{ V}$.

2.

A uniformly doped silicon npn bipolar transistor at $T = 300 \text{ K}$ has parameters $N_E = 2 \times 10^{18} \text{ cm}^{-3}$, $N_B = 2 \times 10^{16} \text{ cm}^{-3}$, $N_C = 2 \times 10^{15} \text{ cm}^{-3}$, $x_{BO} = 0.85 \mu\text{m}$, and $D_B = 25 \text{ cm}^2/\text{s}$. Assume $x_{BO} \ll L_B$ and let $V_{BE} = 0.650 \text{ V}$. (a) Determine the electron diffusion current density in the base for (i) $V_{CB} = 4 \text{ V}$, (ii) $V_{CB} = 8 \text{ V}$, and (iii) $V_{CB} = 12 \text{ V}$. (b) Estimate the Early voltage.

3.

A uniformly doped pnp silicon bipolar transistor has a base doping of $N_B = 10^{16} \text{ cm}^{-3}$, a collector doping of $N_C = 10^{15} \text{ cm}^{-3}$, a metallurgical base width of $x_{BO} = 0.70 \mu\text{m}$, a base minority carrier diffusion coefficient of $D_B = 10 \text{ cm}^2/\text{s}$, and a B-E cross-sectional area of $A_{BE} = 10^{-4} \text{ cm}^2$. The transistor is biased in the forward-active mode with $V_{EB} = 0.625 \text{ V}$. Neglecting the B-E space charge width and assuming $x_B \ll L_B$, (a) determine the change in neutral base width as V_{BC} changes from 1 to 5 V, (b) find the corresponding change in collector current, (c) estimate the Early voltage, and (d) find the output resistance.

4.

(a) A Schottky barrier diode formed on n-type silicon has a doping concentration of $N_d = 5 \times 10^{15} \text{ cm}^{-3}$ and a barrier height of $\phi_{B0} = 0.65 \text{ V}$. Determine the built-in potential barrier V_{bi} . (b) If the doping concentration changes to $N_d = 10^{16} \text{ cm}^{-3}$, determine the values of ϕ_{B0} and V_{bi} . Do these values increase, decrease, or remain the same? (c) Repeat part (b) if the doping concentration is $N_d = 10^{15} \text{ cm}^{-3}$.

5.

(a) Consider a Schottky diode at $T = 300 \text{ K}$ that is formed with tungsten on n-type silicon. Use Figure 9.5 to determine the barrier height. Assume a doping concentration of $N_d = 10^{16} \text{ cm}^{-3}$ and assume a cross-sectional area $A = 10^{-4} \text{ cm}^2$. Determine the forward-bias voltage required to induce a current of (i) $10 \mu\text{A}$, (ii) $100 \mu\text{A}$, and (iii) 1 mA . (b) Repeat part (a) for a temperature of $T = 350 \text{ K}$. (Neglect the barrier lowering effect.)

6.

A pn junction diode and a Schottky diode each have cross-sectional areas of $A = 8 \times 10^{-4} \text{ cm}^2$. The reverse saturation current densities at $T = 300 \text{ K}$ for the pn junction diode and Schottky diode are $8 \times 10^{-13} \text{ A/cm}^2$ and $6 \times 10^{-9} \text{ A/cm}^2$, respectively. Determine the required forward-bias voltage in each diode to yields currents of (a) $150 \mu\text{A}$, (b) $700 \mu\text{A}$, and (c) 1.2 mA .

7.

(a) The contact resistance of an ohmic contact is $R_c = 5 \times 10^{-5} \Omega\text{-cm}^2$. The cross-sectional area of the junction is 10^{-5} cm^2 . Determine the voltage across the junction if the current is (i) $I = 1 \text{ mA}$ and (ii) $I = 100 \mu\text{A}$. (b) Repeat part (a) if the cross-sectional area is 10^{-6} cm^2 .

8.

A metal, with a work function $\phi_m = 4.2 \text{ V}$, is deposited on an n-type silicon semiconductor with $\chi_s = 4.0 \text{ V}$ and $E_g = 1.12 \text{ eV}$. Assume no interface states exist at the junction. Let $T = 300 \text{ K}$. (a) Sketch the energy-band diagram for zero bias for the case when no space charge region exists at the junction. (b) Determine N_d so that the condition in part (a) is satisfied. (c) What is the potential barrier height seen by electrons in the metal moving into the semiconductor?

9.

A metal–semiconductor junction is formed between a metal with a work function of 4.3 eV and p-type silicon with an electron affinity of 4.0 eV . The acceptor doping concentration in the silicon is $N_a = 5 \times 10^{16} \text{ cm}^{-3}$. Assume $T = 300 \text{ K}$. (a) Sketch the thermal equilibrium energy-band diagram. (b) Determine the height of the Schottky barrier. (c) Sketch the energy-band diagram with an applied reverse-biased voltage of $V_R = 3 \text{ V}$. (d) Sketch the energy-band diagram with an applied forward-bias voltage of $V_a = 0.25 \text{ V}$.